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# ***Smart Photonic and Optoelectronic Integrated Circuits XX***

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El-Hang Lee**  
*Editors*

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# Contents

vii	<i>Authors</i>
ix	<i>Conference Committee</i>

---

## MID-INFRARED OPTOELECTRONICS

---

10536 02	<b>Electrically pumped VCSELs using type-II quantum wells for the mid-infrared (Invited Paper)</b> [10536-1]
10536 03	<b>III-V/silicon photonic integrated circuits for spectroscopic sensing in the 2<math>\mu</math>m wavelength range (Invited Paper)</b> [10536-2]

---

## METAMATERIALS AND METASURFACES II

---

10536 0E	<b>Threshold-less Cherenkov radiation in hyperbolic metamaterial (Invited Paper)</b> [10536-14]
----------	---

---

## LAB-ON-FIBER TECHNOLOGIES I

---

10536 0I	<b>Hollow-core negative curvature fiber: a novel platform for lab-on-a-fiber (Invited Paper)</b> [10536-17]
----------	--

---

## SMART PLASMONICS AND METAMATERIALS

---

10536 0R	<b>Tunable plasmonic resonance in wide wavelength range for smart photonic and optoelectronic applications (Invited Paper)</b> [10536-27]
10536 0S	<b>Ultra-compact plasmonic-oxide electro-optic modulator</b> [10536-29]

---

## SMART STRUCTURES FOR PHOTONIC INTEGRATION

---

10536 13	<b>Towards integrated devices for ultrafast all-optical signal processing in optical networks (Invited Paper)</b> [10536-39]
10536 14	<b>Nonlinear plasmonic metasurfaces (Invited Paper)</b> [10536-40]

10536 15 **Leveraging photonic integration to enhance performance in datacom optical links (Invited Paper)** [10536-41]

---

**INTEGRATION OF MICROWAVE PHOTONIC DEVICES AND SYSTEMS II**

---

10536 1C **Advances on silicon-based integrated microwave photonics (Invited Paper)** [10536-48]

10536 1F **Recent progress in nano-optomechanical devices at microwave frequencies (Invited Paper)** [10536-51]

10536 1G **Programmable universal microwave-photonic filter based on cascaded dual-ring assisted MZIs (Invited Paper)** [10536-52]

10536 1H **Narrowband plasmonic metamaterial absorber integrated pyroelectric detectors towards infrared gas sensing (Invited Paper)** [10536-53]

---

**INTEGRATION OF MICROWAVE PHOTONIC DEVICES AND SYSTEMS III**

---

10536 1I **Electro-photonics: an emerging field for photonic integrated circuits (Invited Paper)** [10536-54]

10536 1K **Reconfigurable photonic integrated circuits on silicon (Invited Paper)** [10536-56]

10536 1L **Ultra-silicon-rich nitride devices for high nonlinear figure of merit optical signal processing (Invited Paper)** [10536-57]

---

**SMART OPTICAL SENSING**

---

10536 1O **Resonant coupling from photonic crystal surfaces to plasmonic nanoantennas: principles, detection instruments, and applications in digital resolution biosensing (Invited Paper)** [10536-60]

---

**SMART FABRICATION AND PHOTONIC INTEGRATION**

---

10536 1T **Advancing silicon photonics by germanium ion implantation into silicon (Invited Paper)** [10536-65]

10536 1U **Photoinduced functional materials by femtosecond laser direct writing (Invited Paper)** [10536-66]

---

#### SMART PIC AND OPTICAL FIBER COMMUNICATION

---

- 10536 1X     **Data center links beyond 100 Gbit/s per wavelength (Invited Paper)** [10536-70]
- 10536 1Y     **Advanced modulation formats for large capacity data center networks (Invited Paper)**  
[10536-71]

---

#### LIDAR TECHNOLOGIES

---

- 10536 20     **Design of pulsed scanning lidar without mutual interferences** [10536-73]

---

#### POSTER SESSION

---

- 10536 22     **Development of a wearable for oximetry and patient physical activity correlation** [10536-76]
- 10536 23     **Effects of fog attenuation on lidar data in urban environment** [10536-77]
- 10536 24     **Virtual prototyping of complex photonic components and integrated circuits for polymer-based integration platform** [10536-78]
- 10536 26     **Electrically tunable subwavelength grating using transparent conductive oxide** [10536-80]



# Authors

Numbers in the index correspond to the last two digits of the seven-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first five digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Ahmed, Md Shakil, 13  
Amann, Markus-Christian, 02, 03  
Andrejew, A., 02  
Ashraf, Imran, 23  
Baets, Roel, 03  
Baks, Christian W., 15  
Berini, P., 14  
Bnyamin, Mario, 1Y  
Boehm, Gerhard, 03  
Buendía, Ivette, 22  
Calà Lesina, A., 14  
Cao, Wei, 1T  
Chen, Jianping, 1G  
Chen, Lawrence R., 13  
Chen, Xia, 1T  
Choi, J. W., 1L  
Conradi, H., 24  
Cunningham, Brian T., 1O  
Dai, Daoxin, 1K  
de Felipe, D., 24  
Ding, Wei, 0I  
Ding, Yunhong, 1C  
Dong, Jianji, 1C  
Dupuis, Nicolas, 15  
Eom, Jeongsook, 20  
Feuer, Mark, 1Y  
Franz, Yohann, 1T  
Gao, Qian, 0S, 26  
Gao, Shoufei, 0I  
Ghamsari, B., 14  
Gill, Douglas M., 15  
Glesk, Ivan, 13  
González, Erika, 22  
Green, William M. J., 15  
Hautefeuille, Mathieu, 22  
Huang, Qinglan, 1O  
Huang, Yidong, 0E  
Jiang, Xin, 1Y  
Kahn, Joseph M., 1X  
Keil, N., 24  
Khokhar, Ali Z., 1T  
Kim, Gunzung, 20  
Kleinert, M., 24  
Krause Perin, Jose, 1X  
Kresse, M., 24  
Lee, Benjamin G., 15  
Li, Erwen, 0S, 26  
Li, Junyu, 1H  
Littlejohns, Callum, 1T  
Liu, Dajian, 1K  
Liu, Fang, 0E  
Liu, Huan, 1H  
Liu, Jui-Nung, 1O  
Liu, Keng-Ku, 1O  
Lowery, Arthur J., 1I  
Lu, Liangjun, 1G  
Mailis, Sakellaris, 1T  
Malik, Aditya, 03  
Margarito, Daniela, 22  
Milosevic, Milan M., 1T  
Mingaleev, S., 24  
Miura, Kiyotaka, 1U  
Muneeb, Muhammad, 03  
Nakanishi, Yuta, 1U  
Ng, D. K. T., 1L  
Okamoto, Koichi, 0R  
Ooi, K. J. A., 1L  
Park, Yongwan, 20, 23  
Peacock, Anna C., 1T  
Polatynski, A., 24  
Qiu, Huaqing, 1C  
Ramunno, L., 14  
Reed, Graham T., 1T  
Richter, A., 24  
Roelkens, Gunther, 03  
Runge, Antoine F. J., 1T  
Sahin, E., 1L  
Sakakura, Masaaki, 1U  
Selman, Moisés, 22  
Shastri, Anujit, 1X  
Shimizu, Masahiro, 1U  
Shimotsuma, Yasuhiko, 1U  
Šimonytė, Ieva, 03  
Singamaneni, Srikanth, 1O  
Sokolov, E., 24  
Sprengel, Stephan, 02, 03  
Sun, Qiankun, 1G  
Sun, Xiankai, 1F  
Tan, D. T. H., 1L  
Tan, Xiaochao, 1H  
Thomson, David J., 1T  
Tsang, Hon Ki, 1F  
Vasiliev, Anton, 03  
Veerabathran, G. K., 02  
Vizbaras, Augustinas, 03  
Vizbaras, Kristijonas, 03  
Wang, Alan X., 0S, 26  
Wang, Pu, 0I

Wang, Ruijun, 03  
Wang, Shipeng, 1K  
Wang, Xiao-Cong, 0I  
Wang, Xu, 1C  
Wang, Ying-Ying, 0I  
Wang, Zifei, 13  
Xiao, Sanshui, 1C  
Xing, P., 1L  
Yan, Siqi, 1C  
Yang, Ao, 1H  
Yi, Fei, 1H  
Yu, Yuan, 1C  
Yu, Zejie, 1F  
Zawadzki, C., 24  
Zhang, Xinliang, 1C  
Zhao, Yuhe, 1C  
Zhou, Linjie, 1G  
Zhou, Wen, 1F  
Zhuang, Leimeng, 1I

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- 3 Metamaterials and Metasurfaces II  
**Jian Wang**, Huazhong University of Science and Technology (China)  
**Lei Zhou**, Fudan University (China)
- 4 Modulators I: Joint Session with Conferences 10536 and 10537  
**Andrew P. Knights**, McMaster University (Canada)
- 5 Modulators II: Joint Session with Conferences 10536 and 10537  
**Sailing He**, KTH Royal Institute of Technology (Sweden) and Zhejiang University (China)
- 6 Lab-on-Fiber Technologies I  
**Heike Ebendorff-Heidepriem**, The University of Adelaide (Australia)  
**Yinlan Ruan**, The University of Adelaide (Australia)
- 7 Lab-on-Fiber Technologies II  
**Heike Ebendorff-Heidepriem**, The University of Adelaide (Australia)  
**Yinlan Ruan**, The University of Adelaide (Australia)
- 8 Smart Plasmonics and Metamaterials  
**Stefan A. Maier**, Imperial College London (United Kingdom)  
**Sailing He**, KTH Royal Institute of Technology (Sweden) and Zhejiang University (China)
- 9 Metamaterials and Metasurfaces III  
**Jian Wang**, Huazhong University of Science and Technology (China)  
**Natalia M. Litchinitser**, University at Buffalo (United States)  
**Wiktor T. Walasik**, University at Buffalo (United States)
- 10 Smart Photonic Components and Optical Sensing  
**Ashok Maliakal**, LGS Innovations Inc. (United States)
- 11 Smart Structures for Photonic Integration  
**Pavel Cheben**, National Research Council Canada (Canada)
- 12 Integration of Microwave Photonic Devices and Systems I  
**Jianji Dong**, Huazhong University of Science and Technology (China)

- 13 Integration of Microwave Photonic Devices and Systems II  
**Jianji Dong**, Huazhong University of Science and Technology (China)  
**Shilong Pan**, Nanjing University of Aeronautics and Astronautics  
(China)
- 14 Integration of Microwave Photonic Devices and Systems III  
**Jianji Dong**, Huazhong University of Science and Technology (China)
- 15 Smart Optical Sensing  
**Alan X. Wang**, Oregon State University (United States)  
**Sailing He**, KTH Royal Institute of Technology (Sweden) and Zhejiang  
University (China)
- 16 Smart Fabrication and Photonic Integration  
**Daoxin Dai**, Zhejiang University (China)
- 17 Smart PIC and Optical Fiber Communication  
**Anhui Liang**, Guangdong University of Technology (China)  
**Yi Cai**, ZTE USA (United States)
- 18 LIDAR Technologies  
**Sailing He**, KTH Royal Institute of Technology (Sweden) and Zhejiang  
University (China)

